

STPS3L40

Power Schottky rectifier

Main product characteristics

I _{F(AV)}	3 A
V _{RRM}	40 V
T _j (max)	150° C
V _F (max)	0.44 V

Features and Benefits

- Negligible switching losses
- Low thermal resistance
- Low forward voltage drop
- Avalanche capability specified

Description

Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters. Packaged in SMC, and low profile SMB, this device is intended for use in DC/DC chargers.

A K C
SMC STPS3L40S
K A
SMB flat STPS3L40UF

Order codes

Part Number	Marking
STPS3L40S	S3L4
STPS3L40UF	FS3L4

Table 1. Absolute Ratings (limiting values)

Symbol		Value	Unit		
V _{RRM}	Repetitive peak reverse v	erse voltage			V
	SMC		$T_L = 120^\circ C \delta = 0.5$	2	۸
^I F(AV)	I _{F(AV)} Average forward current	SMB flat	$T_L = 130^\circ C \ \delta = 0.5$	3	A
I _{FSM}	Surge non repetitive forward current		t _p = 10 ms sinusoidal	75	А
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s$ $Tj = 25^{\circ} C$		1300	W	
T _{stg}	Storage temperature rang	-65 to + 175	°C		
Тj	Operating junction temperature ⁽¹⁾			150	°C

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Characteristics 1

Table 2.	Thermal	resistance

Symbol	Parameter	Parameter		
D lunction to la	lunction to load	SMC	18	°C/W
R _{th(j-I)} Junction to lead		SMB flat	10	0/10

Table 3. Static electrical characteristics

Symbol	Parameter	Test Con	Тур.	Max.	Unit	
I _B ⁽¹⁾			V _ V		100	μA
'R`´	IR ⁽¹⁾ Reverse leakage current	$T_j = 125^\circ C$	$V_{R} = V_{RRM}$	16	40	mA
) (1) Energy lands and and	$T_j = 25^\circ C$	I _F = 3 A		0.5	
V _F ⁽¹⁾		$T_j = 125^\circ C$		0.40	0.44	V
V _F ⁽¹⁾ Forward voltage drop	$T_j = 25^\circ C$	1 - 6 4		0.62	v	
		T _j = 125° C	I _F = 6 A	0.52	0.58	

1. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: $P = 0.30 \text{ x } I_{F(AV)} + 0.047 I_{F}^{2}(RMS)$

Figure 1. Average forward power dissipation Figure 2. versus average forward current

Average forward current versus ambient temperature (δ = 0.5) - SMC

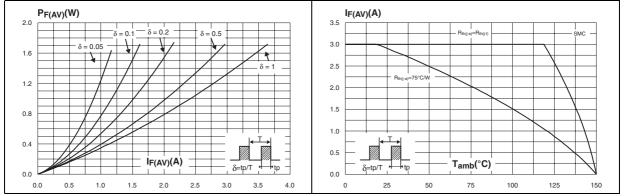
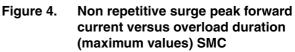
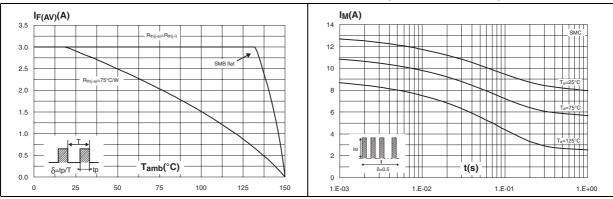




Figure 3. Average forward current versus ambient temperature (δ = 0.5) SMB flat





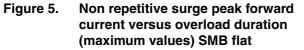


Figure 6. Normalized avalanche power derating versus pulse duration

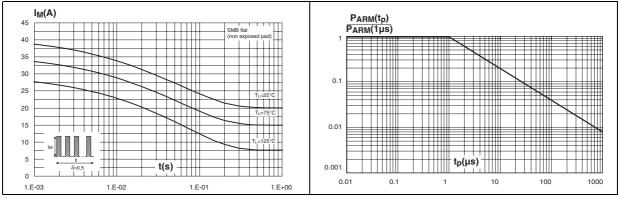
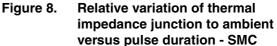


Figure 7. Normalized avalanche power derating versus junction temperature



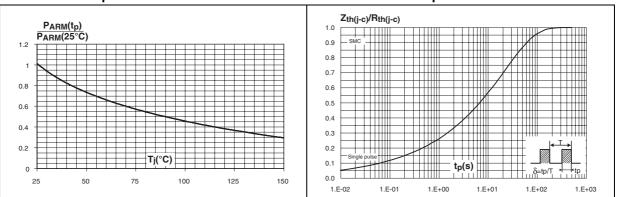
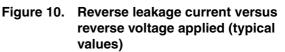


Figure 9. Relative variation of thermal impedance junction to lead versus pulse duration - SMB flat



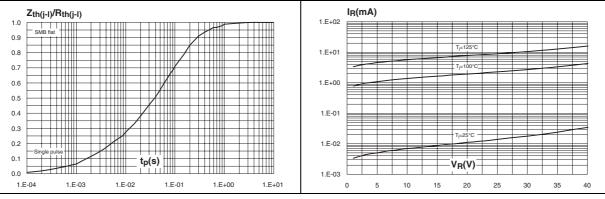


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

Figure 12. Forward voltage drop versus forward current

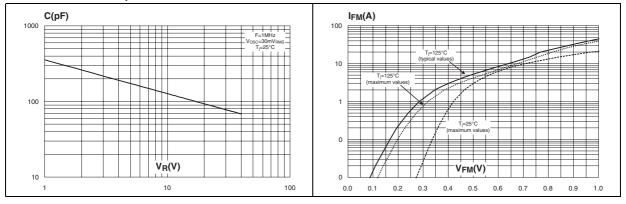
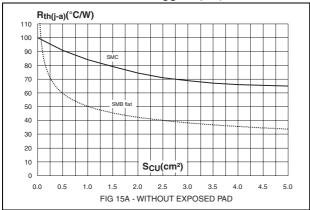


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (epoxy printed board FR4, e_{CU}=35µm)





2 Package Information

• Epoxy meets UL94,V0

Table 4.SMC package mechanical data

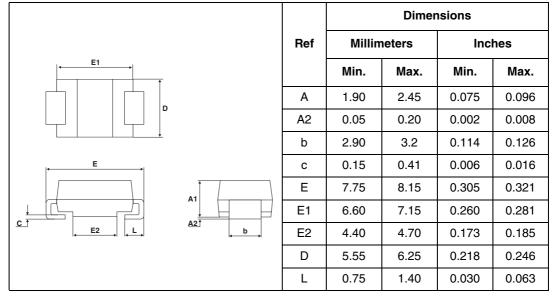
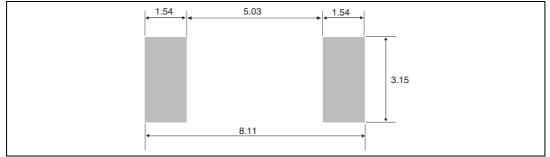


Figure 14. SMC footprint (dimensions in mm)



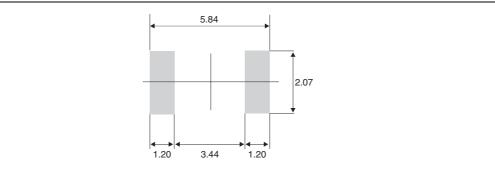


	Dimensions						
	Ref.	Мі	illimete	ers		Inches	
		Min.	Тур.	Max.	Min.	Тур.	Max.
	Α	0.90		1.10	0.035		0.043
	b ⁽¹⁾	1.95		2.20	0.077		0.087
	c ⁽¹⁾	0.15		0.40	0.006		0.016
E E1	D	3.30		3.95	0.130		0.156
↓	E	5.10		5.60	0.200		0.220
	E1	4.05		4.60	0.189		0.181
b	L	0.75		1.50	0.029		0.059
	L1		0.40			0.016	
	L2		0.60			0.024	

Table 5.SMB Flat dimensions

1. Applies to plated leads

Figure 15. SMB Flat footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS3L40S	S3L4	SMC	0.24 g	2500	Tape and reel
STPS3L40UF	FS3L4	SMB flat	0.50 g	5000	Tape and reel

4 Revision history

Date	Revision	Description of Changes
Jul-2003	2A	Last update.
08-Feb-2007	3	Reformatted to current standard. Added ECOPACK statement. Added SMB flat package.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STPS3L40S STPS3L40UF